TMI8263R Dual H-Bridge Motor Driver

FEATURES

- . 8-V to 45-V Operating Supply Voltage Range
- High Output Current Capability
 -2.5-A DC. 2.8-A Peak at 24 V and TA = 25°C
- Dual H-Bridge Motor Driver
 - Single and Dual Brushed DC
 - Stepper
- . Multiple Decay Modes
 - Mixed Decay
 - Slow Decay
 - Fast Decay
- Low Current Sleep Mode
 Built-In 3.3-V Reference Output
- . Protection Features
 - Overcurrent Protection (OCP)
 - Thermal Shutdown (TSD)
 - VM Undervoltage Lockout (UVLO)
 - Fault Condition Indication Pin (nFAULT)
- Small Packages
 - HTSSOP28

APPLICATIONS

- Office Automatic Machines
- Printers and Scanners
- Robotics
- . Gaming Machines
- Factory Automation

GENERAL DESCRIPTION

The TMI8263R provides an integrated motor driver solution for printers, scanners, and other automated equipment applications. The device has two H-bridge drivers, and can drive a bipolar stepper motor or two brushed DC motors. The output driver block consists of N-channel power MOSFETs configured as H-bridges.

A simple PWM interface allows easy interfacing to controller circuits. The TMI8263R is capable of driving up to 2.8-A peak output current per H-bridge.

A low-power sleep mode is provided to achieve ultra- low quiescent current draw by shutting down most of the internal circuitry. Internal protection features are provided for over current, undervoltage and over temperature. Fault conditions are indicated on nFAULT.

The TMI8263R which comply with ROHS specifications, and the lead frame is 100% lead-free.

TYPICAL APPILCATION

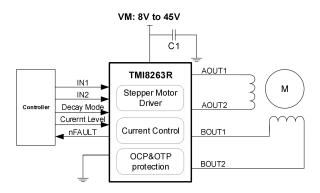


Figure 1. Basic Application Circuit

ABSOLUTE MAXIMUM RATINGS (Note 1)

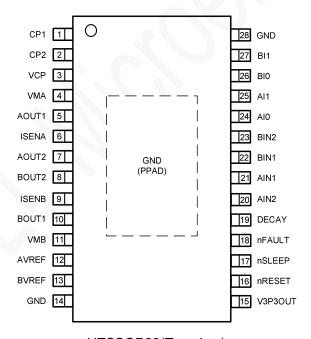
Parameter	Min	Max	Unit
Power supply voltage (VM)	-0.3	48	V
Power supply ramp rate (VMx)		1	V/µs
Digital pin voltage	-0.3	7	V
Reference input pin voltage (VREF)	-0.3	4	V
Continuous motor drive output current	0	2.5	А
Operating ambient temperature, T _A	-40	85	°C
Operating virtual junction temperature, T _{J (Note 2)}	-40	150	°C
Storage temperature T _{stg}	-60	150	°C

ESD RATING

Items	Description	Value	Unit
V	Human body model	±2000	V
V _{ESD}	Charged device model (CDM)	±750	V

JEDEC specification JS-001

PACKAGE/ORDER INFORMATION



HTSSOP28(Top view)

TMI8263R/XXXXX (TMI8263R: Device Code, XXXXX: Inside Code) for TMI8263R

Part Number	Package	Top mark	Quantity/ Reel
TMI8263R	HTSSOP28	TMI8263R	4500
		XXXXX	

The TMI8263R device is Pb-free and RoHS compliant.

PIN FUNCTIONS

	PIN		F 45		
Number	Name	I/O ⁽¹⁾	Function		
14、28	GND	-	Device ground.		
4	\/\/\		Bridge A power supply. Connect a 0.1µF bypass capacitor to		
4	VMA	-	ground, as well as a sufficient bulk capacitance rated for VM.		
11	VMB	_	Bridge B power supply. Connect a 0.1µF bypass capacitor to		
11	VIVID	_	ground, as well as a sufficient bulk capacitance rated for VM.		
15	V3P3OU	0	3.3V regulator output. Bypass to GND with a 0.47-µF 6.3-V		
	T		ceramic capacitor.		
1	CP1	IO	Charge pump flying capacitor. Connect a 0.01-µF 50-V capacitor		
2	CP2	10	between		
			CP2 2 CP1 and CP2.		
3	VCP	10	High-side gate drive voltage. Connect a $0.1\mu F$ ceramic capacitor and $1-M\Omega$ resistor to VM.		
			Bridge A input 1. Logic input controls state of AOUT1. Internal		
21	AIN1	I	pulldown.		
			Bridge A input 2. Logic input controls state of AOUT2. Internal		
20	AIN2	I	pulldown.		
24	AI0	ı	Bridge A current set. Sets bridge A current: 00 = 100%,		
25	Al1	I	01 = 71%, 10 = 38%, 11 = 0. Internal pulldown.		
22	DINIA		Bridge B input 1. Logic input controls state of BOUT1. Internal		
22	22 BIN1 I		pulldown.		
23	23 RINI2 I		23 BIN2 I		Bridge B input 2. Logic input controls state of BOUT2. Internal
	Dii 12	'	pulldown.		
26	BI0	I	Bridge B current set. Sets bridge B current: 00 = 100%,		
27	BI1	ı	01 = 71%, 10 = 38%, 11 = 0. Internal pulldown.		
19	DECAY		Decay mode. Low = slow decay, open = mixed decay, high = fast		
			decay. Internal pulldown and pullup.		
16	nRESET	ı	Reset input. Active-low reset input initializes internal logic and		
			disables the H-bridge outputs. Internal pulldown.		
17	nSLEEP	I	Sleep mode input. Logic high to enable device, logic low to enter		
10	A)/DEE	1	low-power sleep mode. Internal pulldown.		
12	AVREF	l	Bridge A current set reference input.		
13	BVREF	l	Bridge B current set reference input.		
18	nFAULT	OD	Fault. Logic low when in fault condition (overtemperature, overcurrent).		
5	AOUT1	0	Bridge A output 1.		
7	AOUT2	0	Bridge A output 1. Bridge A output 2.		
10	BOUT1	0	Bridge B output 1.		
10	ВООТТ		Driage D output 1.		

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PIN FUNCTIONS_(Continued)

	PIN		Eunotion			
Number	Name	I/O ⁽¹⁾	Function			
8	BOUT2	0	Bridge B output 2.			
6	6 ISENA IO		Bridge A ground / Isense. Connect to current sense resistor for			
U			bridge A.			
0	ICENID	10	Bridge B ground / Isense. Connect to current sense resistor for			
9 ISENB		Ю	bridge B.			

⁽¹⁾ Directions: I = input, O = output, OZ = tri-state output, OD = open-drain output, IO = input/output

RECOMMENDED OPERATING CONDITIONS

Items	Description	Min	Max	Unit
VM	Power supply voltage range	8.0	45	V
VREF	VREF input voltage	1	3.5	V
IV3P3	V3P3OUT load current		10	mA
f _{PWM}	Externally applied PWM frequency	0	100	kHz

⁽¹⁾ All VM pins must be connected to the same supply voltage.

⁽²⁾ Operational at VREF between 0V and 1V, but accuracy is degraded.

ELECTRICAL CHARACTERISTICS

 $T_A = 25$ °C, over recommended operating conditions (unless otherwise noted)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
POWER SUPPLY						
VM operating supply current	I _{VM}	VM = 24 V, f _{PWM} < 50 kHz		3	5	mA
VM sleep mode supply current	I _{VMQ}	VM = 24V		1	10	μA
VM undervoltage lockout voltage	V _{UVLO}	VM rising		6	8	V
Vodocut	V _{3P3}	IOUT = 0 to 1 mA, VM = 24 V, T _J = 25°C	3.18	3.30	3.40	V
V3P3OUT voltage		IOUT = 0 to 1 mA	3.10	3.30	3.50	V
	V _{3P3UVLO}			2		V
LOGIC-LEVEL INPUTS						
Input low voltage	V _{IL}			0.7	0.8	V
Input high voltage	V _{IH}		1.8		5.25	V
Input hysteresis	V _{HYS}			0.45		V
Input low current	I _{IL}	VIN = 0V	-20		20	μA
Input high current	I _{IH}	VIN = 3.3V		35	50	μA
Pulldown resistance	R _{PD}			100		kΩ
nFAULT OUTPUT (OPEN-I	DRAIN OUTI	PUT)				
output low voltage	V _{OL}	I _O = 5 mA			0.5	V
output high leakage current	Іон	V _O = 3.3 V			1	μA
DECAY INPUT						
Input low threshold voltage	V _{IL}	For slow decay mode	0		1.0	V
Input high threshold voltage	V _{IH}	For fast decay mode	2.0			V
Input current		Decay = 5V			±45	μA
Pullup resistance	R _{PU}			130		kΩ
Pulldown resistance	R _{PD}			80		kΩ
H-BRIDGE FETS						
HS FET on resistance	R _{DS(ON)}	VM = 24 V, I _O = 1 A		0.2		Ω
LS FET on resistance	R _{DS(ON)}	VM = 24 V, I _O = 1 A		0.2		Ω
Off-state leakage current	loff		-5		5	μA
MOTOR DRIVER						
Internal PWM frequency	f _{PWM}			40		kHz
Current sense blanking time	tBLANK			3.75		μs
Rise time	t _R	VM = 24 V	30		200	ns
Fall time	t _F	VM = 24 V	30		200	ns
Dead time	t _{DEAD}			20		ns
Input deglitch time	t _{DEG}		1.7		2.5	μs

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ELECTRICAL CHARACTERISTICS (Continued)

T_A = 25°C, over recommended operating conditions (unless otherwise noted)

14 20 0, over recommended operating contained (amount of necess)									
PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT			
CURRENT CONTROL									
xVREF input current	I _{REF}	xVREF = 3.3 V	-3		3	μA			
	V	$xVREF = 3.3 V$, $I_{SENSE} = 0.5 Ω$,	630	660	690	m\/			
	V _{TRIP}	100% current setting	630	660	680	mV			
xISENSE trip voltage		$xVREF = 3.3 V$, $I_{SENSE} = 0.5 Ω$,	445	468	480	mV			
		71% current setting	443			1117			
		$xVREF = 3.3 V$, $I_{SENSE} = 0.5 Ω$,	230	251	265	mV			
		38% current setting	230	251	200	IIIV			
Current sense amplifier gain	Aisense	Reference only		5		V/V			
PROTECTION CIRCUITS									
Overcurrent protection trip level	locp			4.5		Α			
Thermal shutdown temperature	T _{SD (Note3)}		150	170	180	°C			

Note 1: Absolute Maximum Ratings are those values beyond which the life of a device may be impaired.

Note 2: T_J is calculated from the ambient temperature T_A and power dissipation P_D according to the following formula: $T_J = T_A + P_D \times \theta_{JA}$. The maximum allowable continuous power dissipation at any ambient temperature is calculated by $P_{D \text{ (MAX)}} = (T_{J(MAX)} - T_A)/\theta_{JA}$.

Note 3: Thermal shutdown threshold and hysteresis are guaranteed by design.

OPERATION

Overview

The TMI8263R is an integrated motor driver solution for a bipolar stepper motor or two brushed DC motors. The device integrates two NMOS H-bridges, current sense, regulation circuitry, and detailed fault detection. The TMI8263R can be powered with a supply voltage between 8 V and 45 V and is capable of providing an output current up to 2.5A full-scale.

A PWM interface allows for easy interfacing to the controller circuit. The winding current control allows the external controller to adjust the regulated current that is provided to the motor. The current regulation is highly configurable, with three decay modes of operation. Fast, slow, and mixed decay can be selected depending on the application requirements. A low-power sleep mode is included which allows the system to save power when not driving the motor.

A variety of integrated protection features protect the device in the case of a system fault. These include undervoltage lockout (UVLO), charge pump undervoltage (CPUV), overcurrent protection (OCP), and overtemperature shutdown (TSD). Fault conditions are indicated on the nFAULT pin.

Control Modes

The AIN1 and AIN2 input pins directly control the state of the AOUT1 and AOUT2 outputs; similarly, the BIN1 and BIN2 input pins directly control the state of the BOUT1 and BOUT2 outputs. The logic is shown in Table 1.

xOUT1 xIN1 xIN2 xOUT2 0 0 Н 0 1 L 1 0 Η L 1 1 Н Н

Table 1. H-Bridge Control Logic

The control inputs have internal pulldown resistors of approximately 100 k Ω .

Current Regulation

In TMI8263R, motor peak current can be limited by the analog reference input VREF and the resistance of external sense resistor on the SENSEx pin approximately according to the below equation:

$$I_{CHOP}(A) = \frac{V_{REF}(V)}{A_{V} \times R_{ISEN}(\Omega)} = \frac{V_{REF}(V)}{5 \times R_{ISEN}(\Omega)}$$

For example:

If VREF = 3.3 V and a R_{ISEN} = 0.5 Ω , the TMI8263R full-scale (100%) chopping current will be 1.32A;

The two input pins (xl1 and xl0) of each H-bridge are set high and low signals; the current in each bridge is scaled to the corresponding percentage of the full-scale current set by the VREF input pin and the sense resistor. The function of the pin is shown in Table 2.

xl1	xI0	RELATIVE CURRENT					
XII	XIU	(% FULL-SCALE CHOPPING CURRENT)					
1	1	0%					
1	0	38%					
0	1	71%					
0	0	100%					

Table 2. H-Bridge xI0,xI1 Pin Functions

For example:

If VREF = 3.3 V and a R_{ISEN} = 0.5 Ω , When the current is set to 100% (xI1, xI0 = 00), the chopping current will be 1.32 A; When the current is set to 71% (xI1, xI0 = 01), the chopping current will be1.32 A x 71% =0.937A; andWhen the current is set to 38% (xI1, xI0 = 10), the chopping current will be1.32 A x 38% =0.502A; If (xI1, xI0 = 11) the bridge will be disabled and no current will flow.

Decay Mode

During PWM current chopping, the H-bridge is enabled to drive current through the motor winding until the PWM current chopping threshold is reached. This is shown in Figure 2 as case 1. The current flow direction shown indicates the state when the xENBL pin is high.

Once the chopping current threshold is reached, the H-bridge can operate in two different states, fast decay or slow decay.

In fast decay mode, once the PWM chopping current level has been reached, the H-bridge reverses state to allow winding current to flow in a reverse direction. As the winding current approaches zero, the bridge is disabled to prevent any reverse current flow. Fast decay mode is shown in Figure 2 as case 2.

In slow decay mode, winding current is re-circulated by enabling both of the low-side FETs in the bridge. This is shown in Figure 2 as case 3.

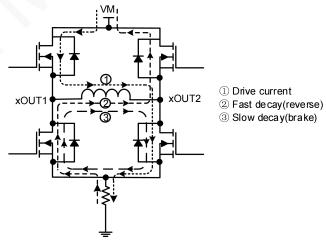


Figure 2. Decay Mode

The TMI8263R supports fast decay, slow decay and a mixed decay mode. Slow, fast, or mixed decay mode is selected by the state of the DECAY pin - logic low selects slow decay, open selects mixed decay operation, and logic high sets fast decay mode. Note that the DECAY pin sets the decay mode for both H-bridges.

Mixed decay mode begins as fast decay, but at a fixed period of time (75% of the PWM cycle) switches to slow decay mode for the remainder of the fixed PWM period.

VM Undervoltage Lockout (UVLO)

If at any time the voltage on the VM pin falls below the undervoltage-lockout threshold voltage, all FETs in the H-bridge will be disabled. Operation resumes when VM rises above the UVLO threshold.

Overcurrent Protection (OCP)

An analog current limit circuit on each FET limits the current through the FET by removing the gate drive. If this analog current limit persists for longer than the OCP time, all FETs in the H-bridge will be disabled and the nFAULT pin will be driven low. The device will remain disabled until either nRESET pin is applied, or VM is removed and reapplied.

Overcurrent conditions on both high and low side devices; that is, a short to ground, supply, or across the motor winding will all result in an overcurrent shutdown. Note that overcurrent protection does not use the current sense circuitry used for PWM current control, and is independent of the I_{SENSE} resistor value or VREF voltage.

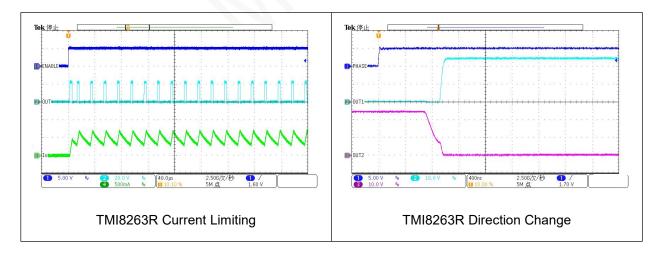
Thermal Shutdown (TSD)

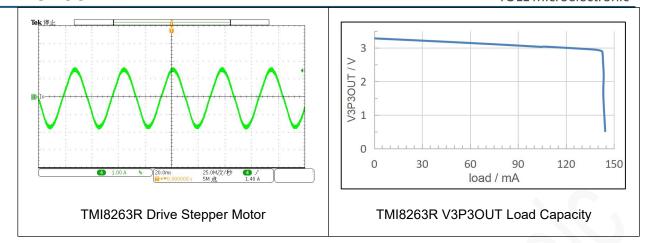
If the die temperature exceeds safe limits, all FETs in the H-bridge are disabled. After the die temperature has fallen to a safe level, operation automatically resumes.

VM Control

In some systems, varying VM as a means of changing motor speed is desirable.

Application Curves





APPLICATION INFORMATION

Application information

The TMI8263R can be used to control a bipolar stepper motor. The PWM interface controls the outputs and current control can be implemented with the internal current regulation circuitry. Detailed fault reporting is provided with the internal protection circuits and nFAULT pin.

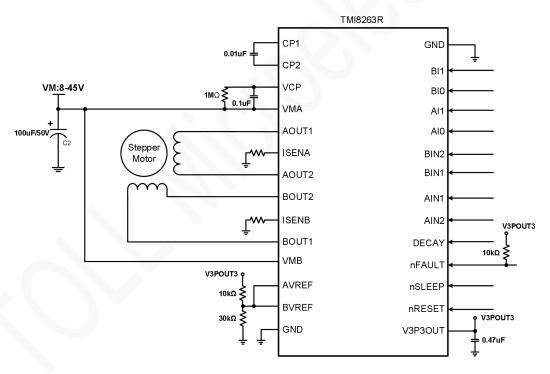


Figure 3. TMI8263R Typical Application

Block Diagram

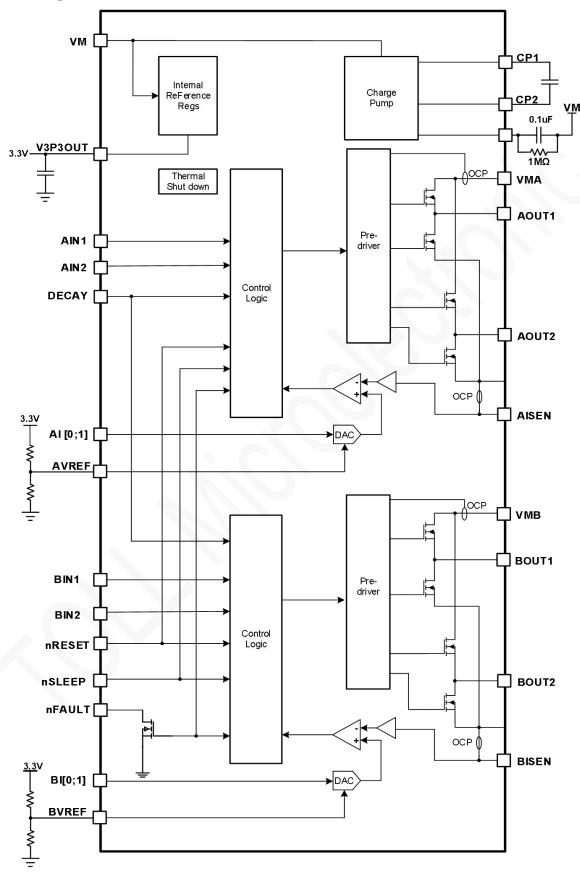
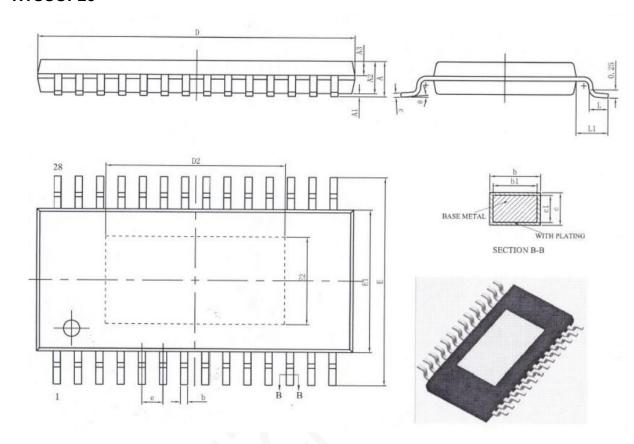


Figure 4. TMI8263R Block Diagram

PACKAGE INFORMATION

HTSSOP28



Unit: mm

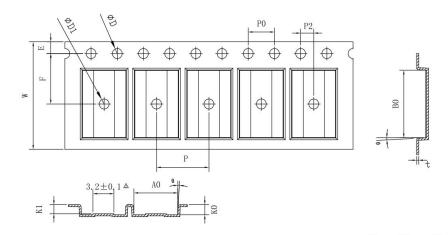
							O1111C. 1111111	
Cymah al	Dimens	sions In Milli	meters	Cymahal	Dimensions In Millimeter			
Symbol	Min	NOM	Max	Symbol	Min	NOM	Max	
Α	-	-	1.20	D2	3.95	4.05	4.15	
A1	0.05	-	0.15	Е	6.20	6.40	6.60	
A2	0.80	-	1.00	E1	4.30	4.40	4.50	
A2	0.39	0.44	0.49	E2	2.75	2.85	2.95	
b	0.20	-	0.29	е	0.65BSC			
b1	0.19	0.22	0.25	L	0.45	0.60	0.75	
С	0.13	-	0.18	L1	1.00BSC			
c1	0.12	0.13	0.15	θ	0°	-	8°	
D	9.60	9.70	9.80					

Note:

- 1) All dimensions are in millimeters.
- 2) Package length does not include mold flash, protrusion or gate burr.
- 3) Package width does not include inter lead flash or protrusion.
- 4) Lead popularity (bottom of leads after forming) shall be 0.10 millimeters max.
- 5) Pin 1 is lower left pin when reading top mark from left to right.

TAPE AND REEL INFORMATION

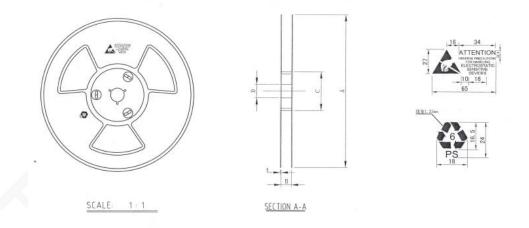
TAPE DIMENSIONS: HTSSOP28



Unit: mm

Symbol	Dimensions	Symbol	Dimensions	Symbol	Dimensions	Symbol	Dimensions
A0	6.70±0.10	θ	5° TYP	Е	1.75±0.10	D1	1.55MIN
В0	10.05±0.10	t	0.30±0.05	F	7.50±0.10	P0	0.30±0.10
K0	1.50±0.10	W	16.00±0.30	P2	2.00±0.10	10P0	40.00±0.20
K1	1.35±0.10	Р	8.00±0.10	D	1.50±0.10		

REEL DIMENSIONS: HTSSOP28



Unit: mm

Ø A	В	øс	ØD	t
329±1.0	16.8±1.0	100±0.5	13.3±0.3	2.0±0.3

Note:

- 1) All Dimensions are in Millimeter
- 2) Quantity of Units per Reel is 4500
- 3) MSL level is level 3.

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